

CIPOS™ Mini

IM513-L6A

Description

The CIPOS™ Mini family offers the chance for integrating various power and control components to increase reliability, optimize PCB size and system costs.

It is designed to control AC motors drive applications like refrigerator. The package concept is specially adapted to power applications, which need good thermal conduction and electrical isolation, but also EMI-save control and overload protection.

3Φ-bridges with CoolMOS™ CFD2 Power MOSFETs are combined with an optimized SOI gate driver for excellent electrical performance.

Features

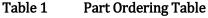
- Fully isolated Dual In-Line molded module
- 650V CoolMOS™ CFD2 Power MOSFETs
- Rugged SOI gate driver technology with stability against transient and negative voltage
- Allowable negative VS potential up to -11V for signal transmission at VBS=15V
- Integrated bootstrap functionality
- Over current shutdown
- Built-in NTC thermistor for temperature monitor
- Under-voltage lockout at all channels
- Low side source pins accessible for all phase current monitoring (open source)
- Cross-conduction prevention
- All of 6 switches turn off during protection
- Lead-free terminal plating; RoHS compliant

Potential applications

Refrigerators, Dish washers, fans, Low power motor drives

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.



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Base Part Number	Package Type	Form	Quantity	Number
IM513-L6A	DIP	20 tubes	280 pcs	IM513L6AXKMA1

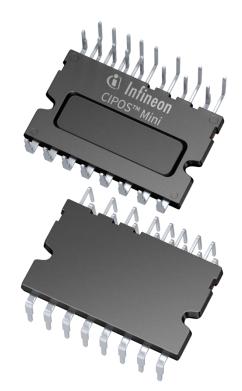




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IM513-L6A

Internal Electrical Schematic



Internal Electrical Schematic 1

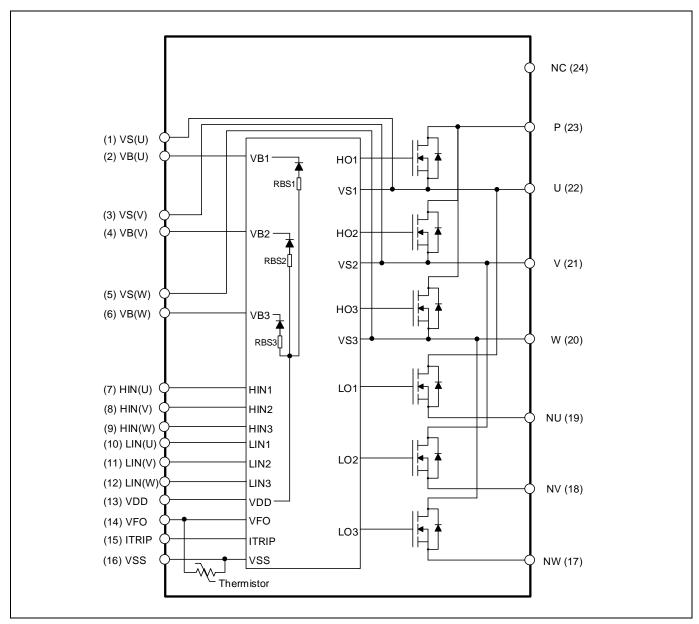


Figure 1 Internal electrical schematic



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Pin Description

Pin Description 2

2.1 Pin Assignment

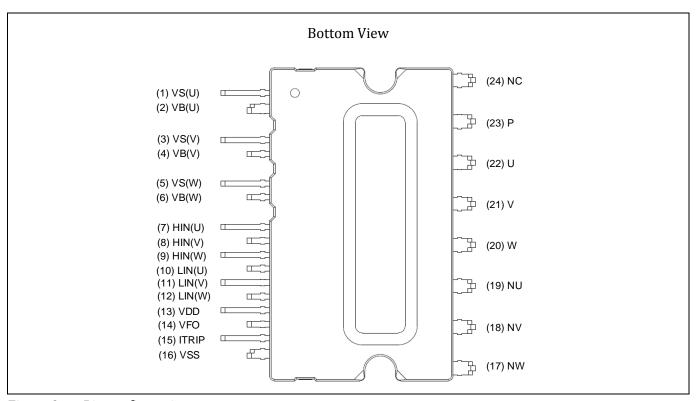
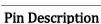


Figure 2 Pin configuration

Table 1 Pin assignment

Pin Number	Pin name	Pin Description
1	VS(U)	U-phase high side floating IC supply offset voltage
2	VB(U)	U-phase high side floating IC supply voltage
3	VS(V)	V-phase high side floating IC supply offset voltage
4	VB(V)	V-phase high side floating IC supply voltage
5	VS(W)	W-phase high side floating IC supply offset voltage
6	VB(W)	W-phase high side floating IC supply voltage
7	HIN(U)	U-phase high side gate driver input
8	HIN(V)	V-phase high side gate driver input
9	HIN(W)	W-phase high side gate driver input
10	LIN(U)	U-phase low side gate driver input
11	LIN(V)	V-phase low side gate driver input
12	LIN(W)	W-phase low side gate driver input
13	VDD	Low side control supply
14	VFO	Fault output / Temperature monitor(L6A only)
15	ITRIP	Over current shutdown input
16	VSS	Low side control negative supply
17	NW	W-phase low side source
18	NV	V-phase low side source

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Pin Number	Pin name	Pin Description
19	NU	U-phase low side source
20	W	Motor W-phase output
21	V	Motor V-phase output
22	U	Motor U-phase output
23	P	Positive bus input voltage
24	NC	No Connection

2.2 **Pin Description**

HIN(U, V, W) and LIN(U, V, W) (Low side and high side control pins, Pin 7 - 12)

These pins are positive logic and they are responsible for the control of the integrated MOSFET. The Schmitt-trigger input thresholds of them are such to guarantee LSTTL and CMOS compatibility down to 3.3V controller outputs. Pull-down resistor of about $5k\Omega$ is internally provided to pre-bias inputs during supply start-up and a zener clamp is provided for pin protection purposes. Input Schmitt-trigger and noise filter provide beneficial noise rejection to short input pulses.

The noise filter suppresses control pulses which are below the filter time t_{FILIN} . The filter acts according to Figure 4.

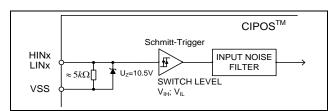
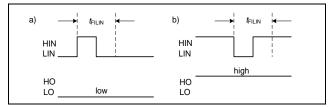


Figure 3 Input pin structure



Input filter timing diagram Figure 4

It is not recommended for proper work to provide input pulse-width lower than 1µs.

The integrated gate drive provides additionally a shoot through prevention capability which avoids the simultaneous on-state of two gate drivers of the same leg (i.e. HO1 and LO1, HO2 and LO2, HO3 and LO3). When two inputs of a same leg are

activated, only former activated one is activated so that the leg is kept steadily in a safe state.

A minimum deadtime insertion of typically 380ns is also provided by driver IC, in order to reduce cross-conduction of the external power switches.

VFO (Fault-output and NTC, Pin 14)

The VFO pin indicates a module failure in case of under voltage at pin VDD or in case of triggered over current detection at ITRIP. A pull-up resistor is externally required. (In case of L6AH, there is no NTC thermistor.)

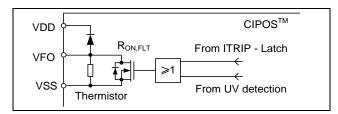


Figure 5 Internal circuit at pin VFO

The same pin provides direct access to the NTC, which is referenced to VSS. An external pull-up resistor connected to +5V ensures that the resulting voltage can be directly connected to the microcontroller.

ITRIP (Over current detection function, Pin 15)

CIPOS™ Mini provides an over current detection function by connecting the ITRIP input with the MOSFET drain current feedback. The ITRIP comparator threshold (typ. 0.47V) is referenced to VSS ground. An input noise filter (typ.: t_{ITRIPMIN} = 530ns) prevents the driver to detect false overcurrent events.

Over current detection generates a shutdown of all outputs of the gate driver after the shutdown propagation delay of typically 1000ns.

The fault-clear time is set to minimum 40µs.



Pin Description

VDD, VSS (Low side control supply and reference, Pin 13, 16)

VDD is the control supply and it provides power both to input logic and to output power stage. Input logic is referenced to VSS ground.

The under-voltage circuit enables the device to operate at power on when a supply voltage of at least a typical voltage of $V_{DDUV+} = 12.1V$ is present.

The IC shuts down all the gate drivers power outputs, when the VDD supply voltage is below $V_{DDUV} = 10.4V$. This prevents the external power switches from critically low gate voltage levels during on-state and therefore from excessive power dissipation.

VB(U, V, W) and VS(U, V, W) (High side supplies, Pin 1 - 6)

VB to VS is the high side supply voltage. The high side circuit can float with respect to VSS following the external high side power device source voltage.

Due to the low power consumption, the floating driver stage is supplied by integrated bootstrap circuit.

The under-voltage detection operates with a rising supply threshold of typical $V_{BSUV+} = 12.1V$ and a falling threshold of $V_{BSUV} = 10.4V$.

VS(U, V, W) provide a high robustness against negative voltage in respect of VSS of -50V transiently. This ensures very stable designs even under rough conditions.

NW, NV, NU (Low side source, Pin 17 - 19)

The low side sources are available for current measurements of each phase leg. It is recommended to keep the connection to pin VSS as short as possible in order to avoid unnecessary inductive voltage drops.

W, V, U (High side source and low side drain, Pin 20 - 22)

These pins are connected to U, V, W input of a motor.

P (Positive bus input voltage, Pin 23)

The high side MOSFETs are connected to the bus voltage. It is noted that the bus voltage does not exceed 450V.



Absolute Maximum Ratings

3 Absolute Maximum Ratings

 $(V_{DD} = 15V \text{ and } T_J = 25^{\circ}\text{C}, \text{ if not stated otherwise})$

3.1 Module Section

Description	Symbol	Condition	Value	Unit
Storage temperature range	T_{STG}		-40 ~ 125	°C
Operating case temperature	T _C	Refer to Figure 7	-40 ~ 125	°C
Operating junction temperature	T_{J}		-40 ~ 150	°C
Isolation test voltage	V _{ISO}	1min, RMS, $f = 60Hz$	2000	V

3.2 Inverter Section

Description	Symbol	Condition	Value	Unit
Max. blocking voltage	V_{DSS}	$I_D = 250 \mu A$	650	V
DC link supply voltage of P-N	V_{PN}	Applied between P-N	450	V
DC link supply voltage (surge) of P-N	V _{PN(surge)}	Applied between P-N	500	V
Output current	Io	$T_C = 25$ °C, $T_J < 150$ °C	±10	A
Peak output current	I _{O(peak)}	less than 1ms	±12	A
Power dissipation per MOSFET	P _{tot}		29.7	W
Short circuit withstand time ¹	t _{sc}	$V_{DC} \le 400 \text{V}, T_J = 150 ^{\circ} \text{C}$	5	μs

3.3 Control Section

Description	Symbol	Condition	Value	Unit
High side offset voltage	Vs		600	V
Repetitive peak reverse voltage of bootstrap diode	V_{RRM}		600	V
Module supply voltage	V_{DD}		20	V
High side floating supply voltage $(V_B \text{ reference to } V_S)$	V_{BS}		20	V
Input voltage	V _{IN}	LIN, HIN, ITRIP	10	V

 $^{\rm 1}$ Allowed number of short circuits: <1000; time between short circuits: >1s. Datasheet 7 of 20

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Thermal Characteristics



4 Thermal Characteristics

Description	Comple of	Condition		I I an i t			
Description	Symbol	Condition	Min.	Тур.	Max.	Unit	
Single MOSFET thermal resistance, junction-case	R _{thJC}				4.21	K/W	



Recommended Operation Conditions

5 Recommended Operation Conditions

All voltages are absolute voltages referenced to V_{SS} -potential unless otherwise specified.

Description	Comelo al		TT			
Description	Symbol	Min.	Тур.	Max.	Unit	
DC link supply voltage of P-N	V_{PN}	0	-	450	V	
Low side supply voltage	V_{DD}	14.0	15	18.5	V	
High side floating supply voltage (V _B vs. V _S)	V_{BS}	13.5	-	18.5	V	
Logic input voltages LIN, HIN, ITRIP	V_{IN}	0	-	5	V	
PWM carrier frequency	F_{PWM}	•	-	20	kHz	
External deadtime between HIN and LIN	DT	1.5	-	-	μs	
Voltage between VSS - N (including surge)	V_{COMP}	-5	-	5	V	
Minimum input pulse width	PW _{IN(ON)} PW _{IN(OFF)}	1.2	-	-	μs	
Control supply variation	$\Delta V_{BS,} \ \Delta V_{DD}$	-1 -1	-	1 1	V/µs	

Static Parameters



6 Static Parameters

 $(V_{DD} = 15V \text{ and } T_J = 25^{\circ}\text{C}, \text{ if not stated otherwise})$

6.1 Inverter Section

Description	Compale al	C diri		11		
Description	Symbol	Condition	Min.	Тур.	Max.	Unit
Drain-Source on-state resistance	R _{DS(on)}	$I_D = 4.4A$ $T_J = 25^{\circ}C$ $150^{\circ}C$		0.28 0.73	0.33	Ω
Drain-Source leakage current	I _{DSS}	$V_{DS} = 600V$	-	-	1	mA
Diode forward voltage	V_{F}	$I_F = 4.4A$ $T_J = 25^{\circ}C$	-	0.9	-	V

6.2 Control Section

Description	Crossb ol	Combal Condition		Value			
Description	Symbol	Condition	Min.	Тур.	Max.	Unit	
Logic "1" input voltage (LIN, HIN)	V_{IH}		1	2.1	2.5	V	
Logic "0" input voltage (LIN, HIN)	V_{IL}		0.7	0.9	-	V	
ITRIP positive going threshold	$V_{IT,TH+}$		400	470	540	mV	
ITRIP input hysteresis	$V_{IT,HYS}$		ı	70	-	mV	
VDD and VBS supply under voltage positive going threshold	$\begin{matrix} V_{\text{DDUV+}} \\ V_{\text{BSUV+}} \end{matrix}$		10.8	12.1	13.0	V	
VDD and VBS supply under voltage negative going threshold	V _{DDUV} - V _{BSUV} -		9.5	10.4	11.2	V	
VDD and VBS supply under voltage lockout hysteresis	V_{DDUVH} V_{BSUVH}		1.0	1.7	-	V	
Quiescent VB_x supply current $(V_{Bx} \text{ only})$	I_{QBS}	$H_{IN} = 0V$	ı	-	500	μА	
Quiescent VDD supply current (V _{DD} only)	I_{QDD}	$L_{IN} = 0V$, $H_{INX} = 5V$	1	-	900	μА	
Input bias current for LIN, HIN	I_{IN+}	$V_{IN} = 5V$	-	1	1.5	mA	
Input bias current for ITRIP	I _{ITRIP+}	$V_{\rm ITRIP} = 5V$	-	65	150	μΑ	
Input bias current for VFO	I_{FO}	$VFO = 5V, V_{ITRIP} = 0V$	ı	60	-	μΑ	
VFO output voltage	V_{FO}	$I_{FO} = 10$ mA, $V_{ITRIP} = 1$ V	1	0.5	-	V	
Bootstrap diode forward voltage	V_{F_BSD}	IF = 20mA, VS2 and VS3 = 0V	-	2.6	-	V	
Bootstrap resistance	R _{BSD}	Between V_{F1} =4V and V_{F2} =5V	-	40	-	Ω	



Dynamic Parameters

7 Dynamic Parameters

 $(V_{DD} = 15V \text{ and } T_J = 25^{\circ}\text{C}, \text{ if not stated otherwise})$

7.1 Inverter Section

December 1	Cl1	C 114	Value			TT *4
Description	Symbol	Condition	Min.	Тур.	Max.	Unit
Turn-on propagation delay time	ton		-	875	-	ns
Turn-on rise time	$t_{\rm r}$	$V_{LIN, HIN} = 5V,$	-	85	-	ns
Turn-on switching time	$t_{c(on)}$	$I_D = 6A,$ $V_{DC} = 300V$	-	200	-	ns
Reverse recovery time	t_{rr}	VDC 300V	-	115	-	ns
Turn-off propagation delay time	$t_{ m off}$	$V_{\text{LIN, HIN}} = 0V$	-	810	-	ns
Turn-off fall time	t_{f}	$I_D = 6A$,	-	10	-	ns
Turn-off switching time	$t_{c(off)}$	$V_{DC} = 300V$	-	20	-	ns
Short circuit propagation delay time	t _{SCP}	From V _{IT,TH+} to 10% I _{SC}	-	1300	-	ns
MOSFET turn-on energy (includes reverse recovery of diode)	Eon	$V_{DC} = 300V, I_D = 6A$ $T_J = 25^{\circ}C$ $150^{\circ}C$		360 660		μЈ
MOSFET turn-off energy	$E_{ m off}$	$V_{DC} = 300V, I_D = 6A$ $T_J = 25^{\circ}C$ $150^{\circ}C$	-	15 25	-	μЈ
Diode recovery energy	E _{rec}	$V_{DC} = 300V, I_D = 6A$ $T_J = 25^{\circ}C$ $150^{\circ}C$		55 125	-	μJ

Control Section

Donasistics	Complete al	Can diti an	Value			I I i h	
Description	Symbol	Condition	Min.	Тур.	Max.	Unit	
Bootstrap diode reverse recovery time	t _{rr_BS}	$I_F = 0.6A$, $di/dt = 80A/\mu s$	-	50	•	ns	
Input filter time ITRIP	t _{ITRIPmin}	$V_{ITRIP} = 1V$	-	530	-	ns	
Input filter time at LIN, HIN for turn on and off	t _{FILIN}	V _{LIN, HIN} = 0V & 5V	-	290	•	ns	
Fault clear time after ITRIP-fault	t _{FLTCLR}	$V_{ITRIP} = 1V$	40	65	200	μs	
ITRIP to Fault propagation delay	$t_{ ext{FLT}}$	$V_{\text{LIN, HIN}} = 0 \text{ or } V_{\text{LIN, HIN}} = 5V, V_{\text{ITRIP}} = 1V$	-	730	1000	ns	
Internal deadtime	DT_{IC}		-	380	-	ns	
Matching propagation delay time (On and Off) all channels	M_{T}	External dead time >500ns	-	20	100	ns	

 $\frac{\text{IM513-L6A}}{\text{Thermistor}}$



8 Thermistor

Description	Condition	Symbol	Value			IIi-
			Min.	Тур.	Max.	Unit
Resistance	$T_{NTC} = 25^{\circ}C$	R _{NTC}	-	85	ı	kΩ
B-constant of NTC (Negative Temperature Coefficient)		B(25/100)	-	4092	-	К

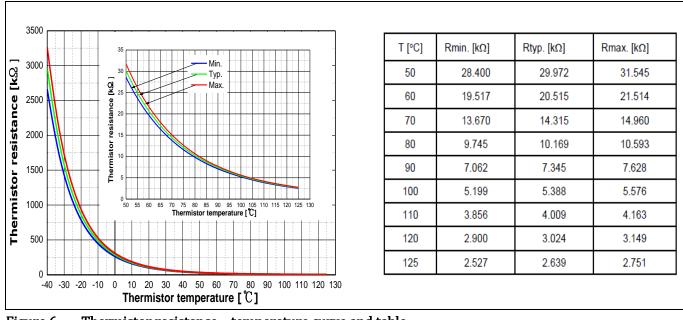


Figure 6 Thermistor resistance – temperature curve and table
(For more information, please refer to the application note 'AN2016-10 CIPOS Mini Technical description')



Mechanical Characteristics and Ratings

9 **Mechanical Characteristics and Ratings**

Description	C 1!#!		11		
Description	Condition	Min.	Тур.	Max.	Unit
Comparative Tracking Index (CTI)		550	-	-	V
Mounting torque	M3 screw and washer	0.59	0.69	0.78	Nm
Backside Curvature	Refer to Figure 8	-50	-	100	μm
Weight		-	6.12	-	g





Qualification Information

Qualification Information 10

UL Certification	File number E314539		
Moisture sensitivity level (SOP23 only)	-		
RoHS Compliant	Yes (Lead-free terminal plating)		
ESD	HBM(Human Body Model) Class 2		
	CDM(Charged Device Model)	Class C3	

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Diagrams and Tables

11 Diagrams and Tables

11.1 T_C Measurement Point

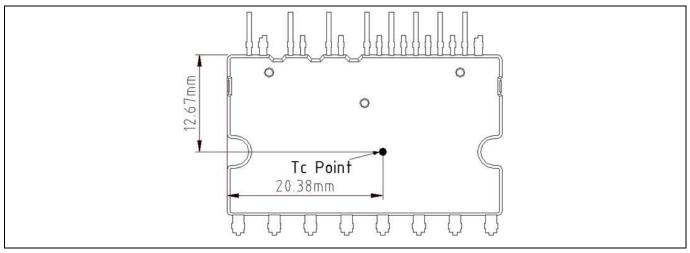


Figure 7 T_C measurement point¹

11.2 Backside Curvature Measurment Point

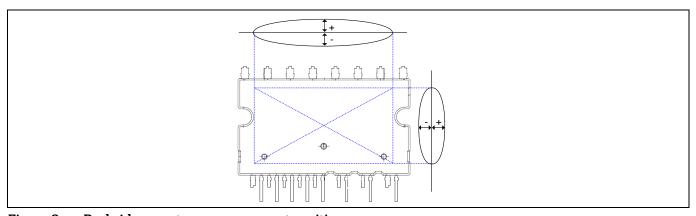


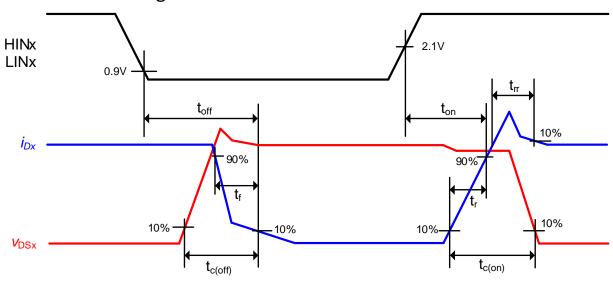
Figure 8 Backside curvature measurement position

 $^{^{1}}$ Any measurement except for the specified point in Figure 7 is not relevant for the temperature verification and brings wrong or different information.



Diagrams and Tables

11.3 Switching Time Definition



 $16 \ of \ 20$

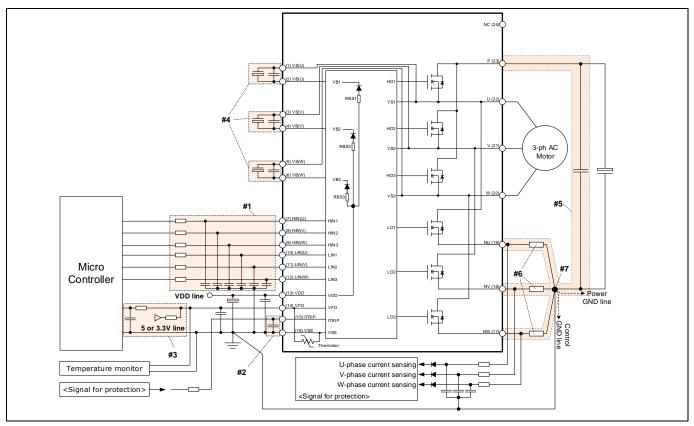
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12.1 **Typical Application Schematic**



Typical application circuit Figure 9

- #1 Input circuit
 - RC filter can be used to reduce input signal noise. (100 Ω , 1nF)
 - The capacitors should be located close to IPM (to V_{SS} terminal especially).
- #2 Itrip circuit
 - To prevent a mis operation of protection function, RC filter is recommended.
 - The capacitor should be located close to Itrip and VSS terminals.
- #3 VFO circuit
 - VFO pin is open drain configuration. This terminal should be pulled up to the bias voltage of the 5V/3.3V through a proper resistor.
 - It is recommended that RC filter is placed close to the controller.
- #4 VB-VS circuit
 - Capacitors for high side floating supply voltage should be placed close to VB and VS terminals.
- #5 Snubber capacitor
 - The wiring among CIPOS™ Mini, snubber capacitor and shunt resistors should be short as possible.
- #6 Shunt resistor
 - SMD type shunt resistors are strongly recommended to minimize its internal stray inductance.
- #7 Ground pattern

Datasheet

- Pattern overlap of Power ground and signal ground Ground should be minimized. Thepatterns should be connected at one end of shunt resistor only for the same potential.



Application Guide

12.2 Performance Chart

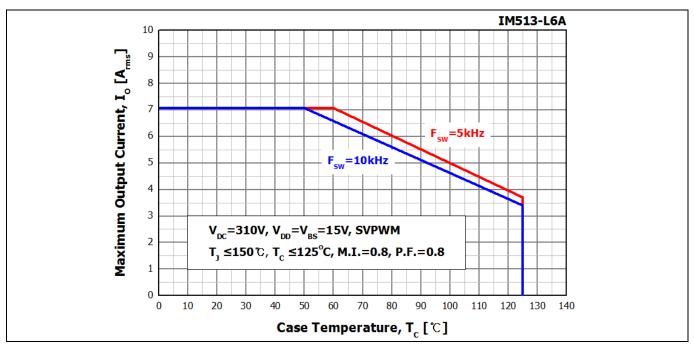


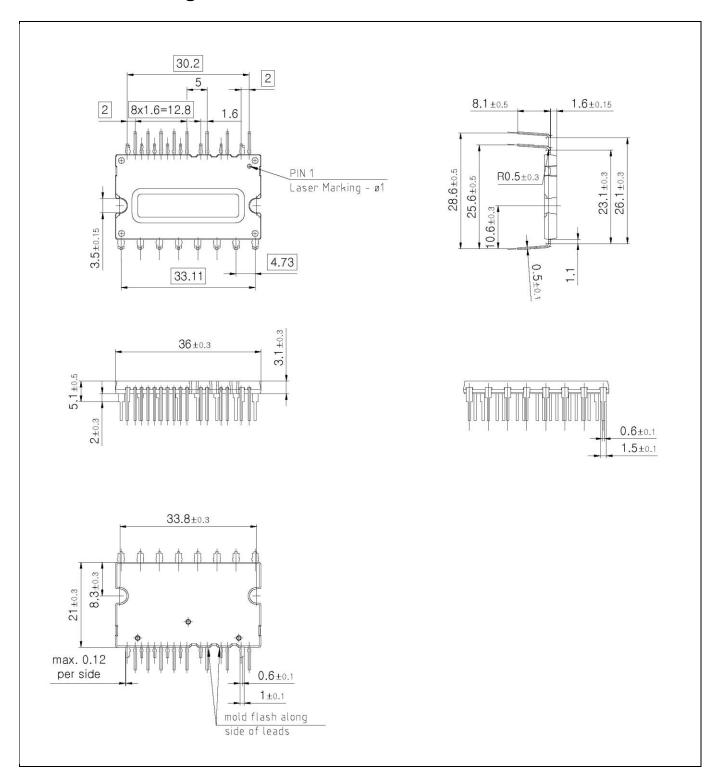
Figure 10 Maximum operating current SOA¹

2017-12-07

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Package Outline

13 Package Outline



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